

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
ALEXANDER KOMPOSCH	05/28/2014
HERMAN HUGO	05/29/2014
SOON ING CHEW	05/23/2014
SIMON WARD	05/29/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	INFINEON TECHNOLOGIES NORTH AMERICA CORP.
<b>Street Address:</b>	640 N. MCCARTHY BLVD
<b>City:</b>	MILPITAS
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<b>Postal Code:</b>	95035
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14297189
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(919)948-3357
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<b>Phone:</b>	919-948-3390
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<b>Correspondent Name:</b>	MURPHY, BILAK & HOMILLER/INFINEON TECHNO
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<b>ATTORNEY DOCKET NUMBER:</b>	1012-0912 / 2014P50725US1
<b>NAME OF SUBMITTER:</b>	JAMES O'NEILL
<b>SIGNATURE:</b>	/James O'Neill, Reg. No. 69924/
<b>DATE SIGNED:</b>	06/05/2014
<b>Total Attachments: 2</b>	
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source=1012-0912_Assignment#page2.tif	

**ASSIGNMENT**

For good and valuable consideration, we,

Alexander KOMPOSCH, a citizen of AUSTRIA, residing at 300 Berkshire Dr., 95037 Morgan Hill, California, USA

Herman HUGO, a citizen of the UNITED STATES, residing at 6410 Firefly Dr., 95120 San Jose, California, USA

Soon Ing CHEW, a citizen of Malaysia, residing at 171 Midwick Dr., 95035 Milpitas, California, USA

Simon WARD, a citizen of the UNITED KINGDOM, residing at 626 St Timothy Place, 95037 Morgan Hill, California, USA

hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies North America Corp.**, having its principal place of business at 640 N. McCarthy Blvd., 95035 Milpitas, California, USA, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on May 23, 2014 as US Serial No. 62/002,348

entitled: **Semiconductor Device Package Having Asymmetric Chip Mounting Area and Lead Widths**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:   
Alexander KOMPOSCH

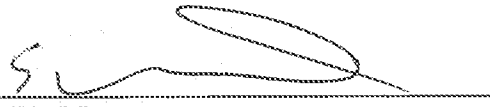
DATE: 05/28/2014

SIGNATURE:   
Herman HUGO

DATE: 5/29/14

SIGNATURE:   
Soon Ing CHEW

DATE: 5/23/14

SIGNATURE:   
Simon WARD

DATE: 5/29/2014